Appln. No. 10/731,546

Response dated December 22, 2004

Reply to Office Action of October 1, 2004

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the applications:

Listing of Claims:

1. (currently amended) An ignition resistant polymeric composite comprising, a) a polymeric substrate which is selected from the group consisting of a polystyrene, an ABS, a polycarbonate, a blend of a polycarbonate and an ABS, a thermoplastic polyurethane, a thermoset polyurethane, a polyetherimide,, a polyaramid, a polyetheretherketone, a polysulfone, a polylactic acid, an epoxy laminate, a vinyl ester laminate, a cyanate ester composite, a polyolefin, a rubber, a polyvinyl chloride, and a terephthalate; b) a flame retardant intermixed with the polymeric substrate in an amount up 7.5 weight percent based on weight of the flame retardant and the substrate; and c) a partially oxidized plasma polymerized organosilicon layer adhered to the substrate.

2. (canceled)

- (currently amended) The ignition resistant polymeric composite of Claim
 12 wherein the plastic substrate is a copolymer blend of a polycarbonate and an ABS.
- 4. (original) The ignition resistant polymeric composite of Claim 3 wherein the flame retardant is an ignition resistant phosphate compound.
- 5. (original) The ignition resistant polymeric composite of Claim 4 wherein the partially oxidized plasma polymerized organosilicon layer adheres to the substrate by way of a surface pretreatment layer.
- 6. (original) The ignition resistant polymeric composite of Claim 5 wherein the surface pretreatment layer is formed by either of 1) plasma pretreatment of the substrate in the presence of oxygen- or nitrogen-

62227A -2-

Appln. No. 10/731,546 Response dated December 22, 2004 Reply to Office Action of October 1, 2004

containing molecules or 2) plasma polymerization of an organosilicon compound using a stoichiometric excess of the organosilicon compound with respect to oxygen.

- 7. (original) The ignition resistant polymeric composite of Claim 6 wherein the surface pretreatment layer is formed by plasma polymerization of an organosilicon compound in the absence of oxygen.
- 8. (currently amended) The ignition resistant polymeric composite of Claim 4 wherein the concentration of the ignition resistant phosphate compound is not greater than 10%-7% by weight, based on the weight of the phosphate and the plastic substrate.
- 9. (currently amended) The ignition resistant polymeric composite of Claim 5 1 wherein the concentration of the ignition resistant phosphate compound is not greater than 7.5% 7% by weight, based on the weight of the phosphate and the plastic substrate.
- 10. (original) The ignition resistant polymeric composite of Claim 7 wherein concentration of the ignition resistant phosphate compound is not greater than 5.5% by weight, based on the weight of the phosphate and the plastic substrate.
- 11. (currently amended) An ignition resistant polymeric composite comprising, a) a substrate containing a blend of a polycarbonate and an ABS; b) a phosphate flame retardant intermixed with the plastic substrate in an amount of not more than 15% based on weight of flame retardant and substrate; c) partially oxidized plasma polymerized organosilicon layer adhered to the substrate; and d) a surface pretreatment layer that promotes adhesion of the partially oxidized plasma polymerized organosilicon layer to the substrate.
- 12. (original) The ignition resistant polymeric composite of Claim 11 wherein the phosphate flame retardant is selected from the group consisting of resorcinol bis(dixylenyl phosphate), bisphenol A diphosphate, and triphenyl phosphate.

62227A -3-

Appln. No. 10/731,546 Response dated December 22, 2004 Reply to Office Action of October 1, 2004

- 13. (original) The ignition resistant polymeric composite of Claim 11 wherein the substrate contains from 60% to 90% of the polycarbonate by weight and from 10% to 40% of the ABS by weight, based on the weight of the polycarbonate and the ABS.
- 14. (original) The ignition resistant polymeric composite of Claim 13 wherein the partially oxidized plasma polymerized organosilicon layer has the formula SiO_xC_yH_z, where x is not less than 1.0; y is not less than 0.2; and z is greater than or equal to 0.
- 15. (original) The ignition resistant polymeric composite of Claim 13 which further includes an SiO_x layer superposing the partially oxidized plasma polymerized organosilicon layer, wherein x is in the range of 1.6 to 2.0.
- 16. (original) The ignition resistant polymeric composite of Claim 11 which is an enclosure for a computer casing, a monitor housing, a calculator, a cell phone, a television set, a DVD player, or a CD players.
- 17. (new) The ignition resistant polymeric composite of claim 11 where the amount of flame retardant is not more than 10 weight percent based on weight of substrate and flame retardant.
- 18. (new) The ignition resistant polymeric composite of claim 11 where the amount of flame retardant is not more than 7 weight percent based on weight of substrate and flame retardant.
- 19. (new) The composite of claim 1 which achieves a V-0 rating in the UL-94 flammability test.
- 20. (new) The composite of claim 11 which achieves a V-0 rating in the UL-94 flammability test.

62227A -4-